



# MOOV

## **Applied Materials (AMAT) Endura II Liner/Barrier**

### Equipment details:

Currently Configured for: 300mm

Asset HDD not included

#### [Chamber 2]

For Ti PVD chamber

DCPS;OPTIMA DCG-200,ENI,for PVD

PUMP/CRYO,OBIS,HELIX

HT ESC type stage

Ar;150/20sccm

#### [Chamber 3]

For TiN PVD chamber

DCPS;OPTIMA DCG-200,ENI,for PVD

PUMP/CRYO,OBIS,HELIX

A101 type stage

Ar/N2;150/200sccm

#### [Chamber 4]

For TiN PVD chamber

DCPS;OPTIMA DCG-200,ENI,for PVD

PUMP/CRYO,OBIS,HELIX

A101 type stage

Ar/N2;150/200sccm

[Chamber C]

For Pre-CLN chamber,PCXT

RFPS;CDX-2000,13.56/2MHz,COMDEL,for BIAS/

SLA PUMP/TMP MAG1300,LEYBOLD.

Ar;200/20sccm

[Chamber D]

For Pre-CLN chamber,PCXT

RFPS;CDX-2000,13.56/2MHz,COMDEL,for BIAS/

SLA PUMP/TMP MAG1300,LEYBOLD.

Ar;200/20sccm

[Chamber E]

For Degas,Plate heater

PUMP/CRYO,HELIX ON-BOARD IS

Ar,press. Controlled

[Chamber F]

For Degas,Plate heater

PUMP/CRYO,HELIX ON-BOARD IS Ar,press.

Controlled